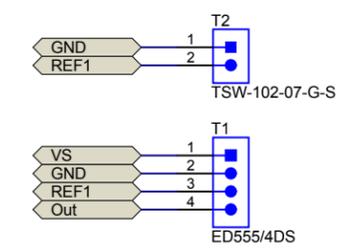
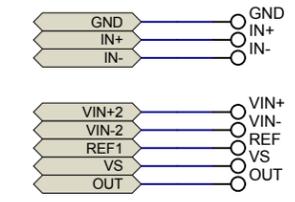
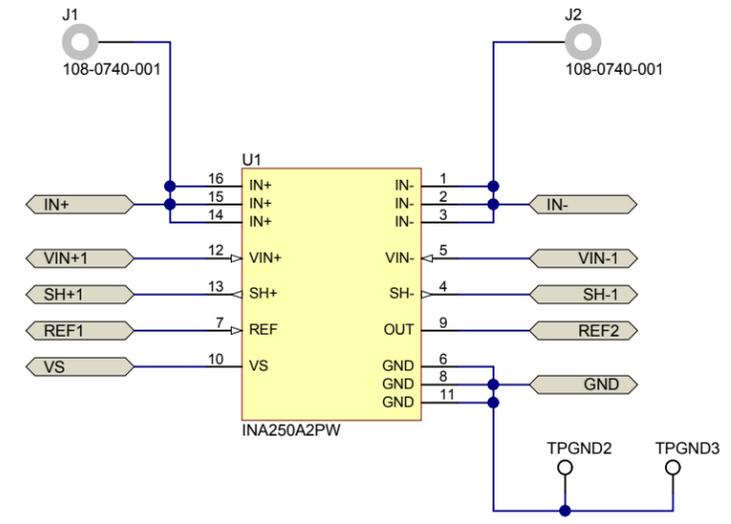
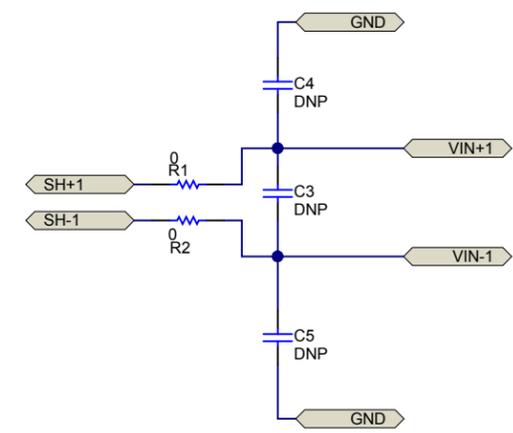
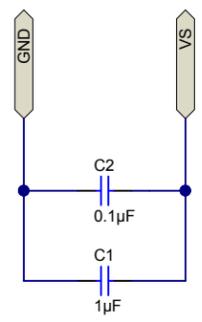
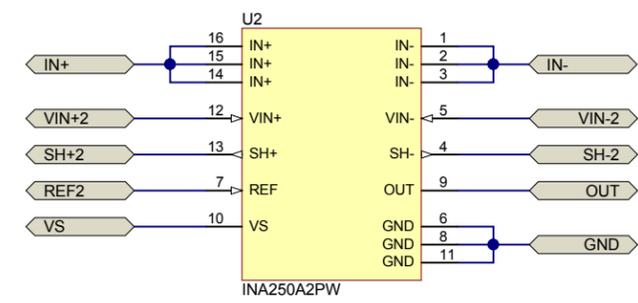
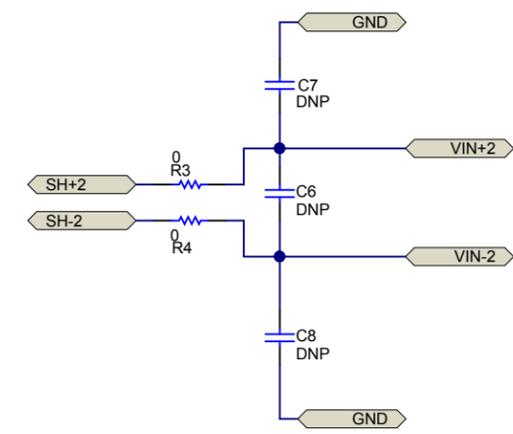


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D

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Orderable: N/A	Designed for: Public Release	Mod. Date: 8/18/2015
TID #: 00614	Project Title: 30A Range Bidirectional Current Shunt Monitor	
Number: TIDA-00614	Rev: A	Sheet: 1 of 2
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: INA250A2 TI Design_BlanckSheet.SchDoc	Size: B
Engineer: Kareem Moulana	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



A

A

PCB Number: TIDA-00614  
PCB Rev: A

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FCC disclaimer

PCB  
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Pb-Free Symbol



B

B

C

C

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

D

D

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TID #: 00614	Project Title: 30A Range Bidirectional Current Shunt Monitor		
Number: TIDA-00614	Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By: Engineer: Kareem Moulana	File: INA250A2 TI Design_TID_Hardware.SchDoc	Contact: http://www.ti.com/support	

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